

Product / Process Change Notification



N° 2016-099-A

Dear Customer,

Please find attached our INFINEON Technologies PCN:

Introduction of Infineon Kulim, Malaysia as an additional wafer test location affecting dedicated products

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **03. July 2017**.
- Infineon aligns with the widely-recognized JEDEC STANDARD “**JESD46**“, which stipulates:
“**Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change.**”

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG
Postal Address Headquarters: Am Campeon 1-12, D-85579 Neubiberg, Phone +49 (0)89 234-0
Chairman of the Supervisory Board: Wolfgang Mayrhuber
Management Board: Dr. Reinhard Ploss (CEO), Dominik Asam, Dr. Helmut Gassel, Jochen Hanebeck
Registered Office: Neubiberg Commercial Register
Amtsgericht München HRB 126492

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► Products affected:

Sales Name	SP N°	OPN	Package
BTN7930B	SP000299767	BTN7930BAUMA1	PG-TO263-7
BTN7933B	SP000481546	BTN7933BAUMA1	PG-TO263-7
BTN7960B	SP000299768	BTN7960BAUMA1	PG-TO263-7
BTN7960P	SP000317942	BTN7960PAKSA1	PG-TO220-7
BTN7963B	SP000481608	BTN7963BAUMA1	PG-TO263-7
BTN7970B	SP000299769	BTN7970BAUMA1	PG-TO263-7
BTN7971B	SP000379686	BTN7971BAUMA1	PG-TO263-7
BTN8960TA	SP000785172	BTN8960TAAUMA1	PG-TO263-7
BTN8962TA	SP001054232	BTN8962TAAUMA1	PG-TO263-7
BTN8980TA	SP000785250	BTN8980TAAUMA1	PG-TO263-7
BTN8982TA	SP001054216	BTN8982TAAUMA1	PG-TO263-7

► Detailed Change Information:

Subject: Introduction of Infineon Kulim, Malaysia as an additional wafer test location affecting dedicated products.

Reason: To continuously ensure the delivery capability to our customers, the wafer test capacity will be extended.

Description:	<u>Old</u>	<u>New</u>
Wafer test location:	■ Infineon Villach, Austria	■ Infineon Villach, Austria <i>or</i> ■ Infineon Kulim, Malaysia

► **Product Identification:** Traceability is ensured by lot number.

► **Impact of Change:** No change in form fit or function and no impact on quality and reliability of the final product.
The wafer test location verification is performed via the Advanced Measurement System Analysis (AMSA) methodology.

► **Attachments:** None

► Time Schedule:

- Final qualification report: AMSA assessment is available on demand
- First samples available: n.a.
- Intended start of delivery: November 2017

If you have any questions, please do not hesitate to contact your local Sales office.